

53252

# 90V - 0.8A DUAL POWER MOSFET OPTOCOUPERS DLA DWG # 5962-03247

**FEATURES:**

- 8-Pin Dual-In-Line Hermetic Package
- Performance over  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$
- Compact Isolation Solid State Switches
- Continuous Output Current: 0.8 A <sup>(1)</sup>
- Optically Coupled between Input and Output
- Isolation Tested to 1000 VDC
- High Level of Transient Immunity
- 3 A Output Surge Current
- Shock and Vibration Resistant
- MIL-PRF-38534 screening optional

**APPLICATIONS:**

- Military/High Reliability Systems
- Standard 28 VDC and 48 VDC Load Driver
- Aircraft Controls
- Electromechanical and Solid State Relay Replacement
- I/O Modules
- Switching Heaters

**DESCRIPTION**

The 53252 is two power MOSFET optocouplers in a single 8-pin dual-in-line package suitable for applications where two independent switches are required. The popular hermetic eight-pin dual-in-line ceramic package combined with 1000 VDC isolation between input and output and between two isolated relays, makes this device ideal for solid-state relay applications. Performance is specified over the full military temperature range. This device is available in a variety of quality levels from COTS to class H including any custom screening requirements. Gold plated leads are standard, but other lead finishes per MIL-PRF-38534 are also available.

Functionally, the device operates as two SPST, normally open (2 Form "A") solid-state relays. Each relay is actuated by an input current, which can be driven from a standard TTL device. The input current biases a light emitting diode that is optically coupled to an integrated photovoltaic diode array. The photovoltaic diode array energizes control circuitry that operates the output MOSFET.

**ABSOLUTE MAXIMUM RATINGS:** (Per relay unless otherwise noted)

Storage Temperature Range .....	$-65^{\circ}\text{C}$ to $+150^{\circ}\text{C}$
Operating Ambient Temperature - $T_A$ .....	$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$
Junction Temperature - $T_J$ .....	$+150^{\circ}\text{C}$
Lead Solder Temperature for 10 seconds .....	$+260^{\circ}\text{C}$
	(1.6 mm below seating plane)
Average Input Current - $I_F$ .....	20 mA
Peak Repetitive Input Current - $I_{Fpk}$ .....	40 mA
	(pulse width < 100 ms; duty cycle < 50%)
Peak Surge Input Current - $I_{Fpk}$ surge .....	100 mA
	(pulse width < 0.2 ms; duty cycle < 0.1%)
Continuous Output Current per relay - $I_O$ .....	0.8 A <sup>(1)</sup>
Single Shot Output Current per relay- $I_{Opk}$ surge (pulse width < 10 ms) .....	3 A
Output Voltage - $V_O$ .....	90 VDC

**RECOMMENDED OPERATING CONDITIONS:**

Parameter	Symbol	Min.	Max.	Units
Input Current (ON)	$I_{F(ON)}$	10	20	mA
Input Voltage (OFF)	$V_{F(OFF)}$	0	0.6	VDC
Operating Temperature	$T_A$	-55	+125	°C

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**ELECTRICAL SPECIFICATIONS**

Test	Symbol	Conditions $-55^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ unless otherwise specified.	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Output Withstand Voltage	$V_{O(\text{OFF})}$	$V_{\text{FOFF}} = 0.6 \text{ V}, I_O = 10 \mu\text{A}$	1, 2, 3	01, 02	90		V
Output On-Resistance 1/	$R_{(\text{ON})}$	$I_{\text{FON}} = 10 \text{ mA}, I_O = 800 \text{ mA},$ pulse duration $\leq 30 \text{ ms}$ , duty cycle $< 10\%$	1, 2, 3	01		1.2	$\Omega$
		$I_{\text{FON}} = 5 \text{ mA}, I_O = 800 \text{ mA},$ pulse duration $\leq 30 \text{ ms}$ , duty cycle $< 10\%$		02		1.2	
Output Leakage Current	$I_{O(\text{OFF})}$	$V_{\text{FOFF}} = 0.6 \text{ V}, V_O = 90 \text{ V}$	1, 2, 3	01, 02		10	$\mu\text{A}$
Input Forward Voltage	$V_{\text{FOFF}}$	$I_{\text{FON}} = 10 \text{ mA}$	1, 2, 3	01	1.0	1.7	V
		$I_{\text{FON}} = 5 \text{ mA}$		02	1.0	1.7	
Input Reverse Breakdown Voltage	$V_R$	$I_R = 10 \mu\text{A}$	1, 2, 3	01, 02	5.0		V
Input-Output Isolation Current 2/	$I_{I-O}$	$V_{I-O} = 1000 \text{ V dc}, t = 5 \text{ s},$ $\text{RH} \leq 65\%, T_A = +25^{\circ}\text{C}$	1	01, 02		1.0	$\mu\text{A}$
Channel-Channel Isolation Current 2/	$I_{\text{ISO}}$	$V_{\text{ISO}} = 1000 \text{ V dc}, t = 5 \text{ s},$ $\text{RH} \leq 65\%, T_A = +25^{\circ}\text{C}$	1	01, 02		1.0	$\mu\text{A}$
Turn-On Time 1/	$t_{\text{ON}}$	$I_{\text{FON}} = 10 \text{ mA}, I_O = 0.8 \text{ A},$ Pulse duration $\leq 30 \text{ ms}$ , duty cycle $< 10\%$	9, 10, 11	01		6.0	ms
		$I_{\text{FON}} = 5 \text{ mA}, I_O = 0.8 \text{ A},$ Pulse duration $\leq 30 \text{ ms}$ , duty cycle $< 10\%$		02		6.0	
Turn-Off time 1/	$t_{\text{OFF}}$	$I_{\text{FON}} = 10 \text{ mA}, I_O = 0.8 \text{ A},$ pulse duration $\leq 30 \text{ ms}$ , duty cycle $< 10\%$	9, 10, 11	01		2.0	ms
		$I_{\text{FON}} = 5 \text{ mA}, I_O = 0.8 \text{ A},$ pulse duration $\leq 30 \text{ ms}$ , duty cycle $< 10\%$		02		2.0	

**NOTES:**

- 1/ During the pulse  $R_{\text{ON}}$  measurement ( $I_O$  duration  $< 30 \text{ ms}$ ), ambient ( $T_A$ ) and case temperature ( $T_C$ ) are equal.  
 2/ This is a momentary withstand test, not a continuous operating condition.

**CAUTION:**

Care should be taken not to exceed the maximum output power dissipation, maximum case temperature, and maximum junction temperature when repetitively switching loads.

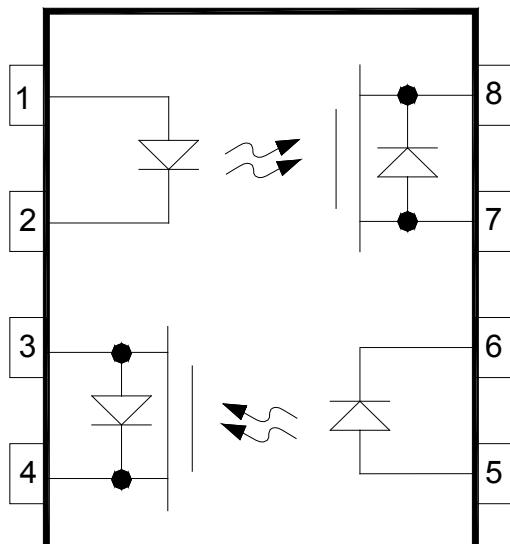


FIGURE 2. Terminal connections.

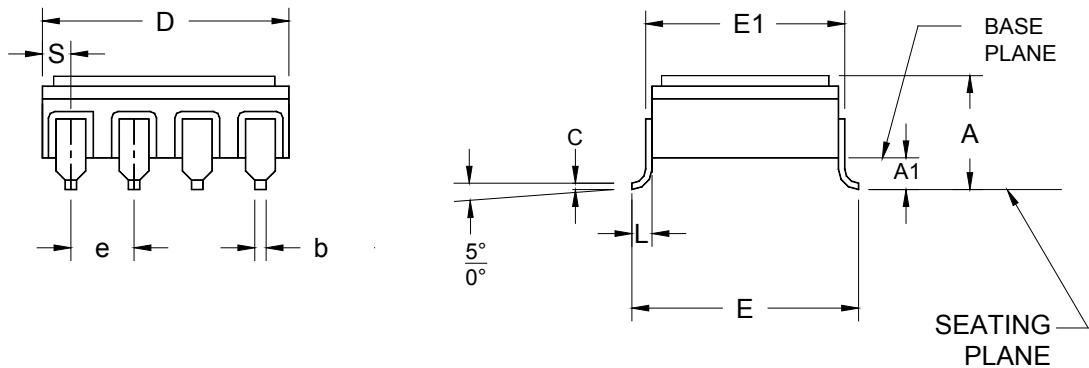
Case outlines		X, Y
Terminal number	Terminal symbol	
1	+IN 1	
2	-IN 1	
3	-OUT 2	
4	+OUT 2	
5	+IN 2	
6	-IN 2	
7	-OUT 1	
8	+OUT 1	

FIGURE 1.

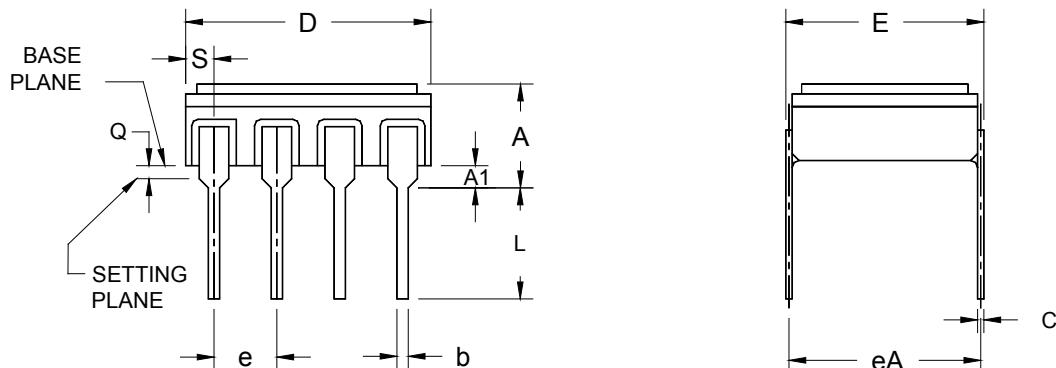
Input	Output
OFF	OFF
ON	ON

FIGURE 3. Truth table(s).

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**Case outline X**

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		6.99		.275
A1	1.40	1.65	.055	.065
b	0.41	0.53	.016	.021
c	0.18	0.33	.007	.013
D	9.40	9.91	.370	.390
e	2.29	2.79	.090	.110
E	9.65	9.91	.380	.390
E1		8.13		.320
L	1.07	1.32	.042	.052
S	0.89	1.27	.035	.050

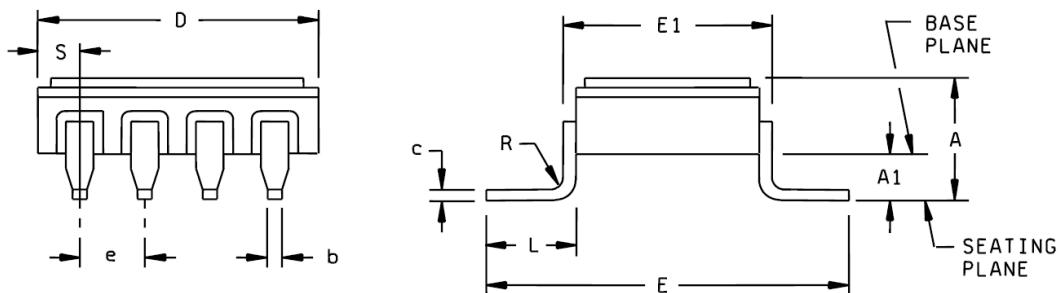
**Case outline Y**

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		6.60		.260
A1	0.76	1.27	.030	.050
b	0.41	0.53	.016	.021
c	0.18	0.33	.007	.013
D	9.40	9.91	.370	.390
e	2.29	2.79	.090	.110
E		8.13		.320
eA	7.37	7.87	.290	.310
L		12.70		.500
Q	0.51		.020	
S	0.89	1.27	.035	.050

## NOTES:

1. The U.S. government preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and in-pound units, the inch-pound units shall rule.
2. Pin 1 is indicated by the ESD triangle(s) marked on top of the package.

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**Case outline Z**

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		4.57		1.80
A1	1.40	1.65	0.055	0.065
b	0.41	0.53	0.016	0.021
c	0.18	0.33	0.007	0.013
D	9.40	9.91	0.370	0.390
e	2.29	2.79	0.090	0.110
E	12.45	12.70	0.490	0.500
E1		7.87		0.310
L	2.34		0.92	
R	0.51 TYP.		.020 TYP	
S	0.89	1.27	0.035	0.050

The following chart explains the ordering procedure for Micropac Part Numbers.

Please contact Micropac for other desired options.

MII PART NUMBER.	STANDARD MILITARY DRAWING PIN	CASE OUTLINE
53252-1HXA	5962-0324701HXA	X
53252-1HXC	5962-0324701HXC	X
53252-1HYA	5962-0324701HYA	Y
53252-1HYC	5962-0324701HYC	Y
53252-1HZA	5962-0324701HZA	Z
53252-1HZC	5962-0324701HZC	Z
53252-2HXA	5962-0324702HXA	X
53252-2HXC	5962-0324702HXC	X
53252-2HYA	5962-0324702HYA	Y
53252-2HYC	5962-0324702HYC	Y
53252-2HZA	5962-0324702HZA	Z
53252-2HZC	5962-0324702HZC	Z

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